

Title (en)

LIGHT EMITTING DEVICE, LIGHT EMITTING DEVICE ARRAY AND LIGHTING APPARATUS INCLUDING THE SAME

Title (de)

LICHEMITTIERENDE VORRICHTUNG, LICHEMITTIERENDE BAUGRUPPE UND BELEUCHTUNGSVORRICHTUNG DAMIT

Title (fr)

DISPOSITIF ÉLECTROLUMINESCENT, RÉSEAU DE DISPOSITIF ÉLECTROLUMINESCENT ET APPAREIL D'ÉCLAIRAGE L'INCLUANT

Publication

EP 3038172 A2 20160629 (EN)

Application

EP 15202624 A 20151223

Priority

KR 20140190407 A 20141226

Abstract (en)

Embodiments provide a light emitting device including a light emitting structure (120) including a first conductivity-type semiconductor layer (122), an active layer (124) disposed on the first conductivity-type semiconductor layer (122) and a second conductivity-type semiconductor layer (126) disposed on the active layer (124), a first electrode (142) conductively contacting the first conductivity-type semiconductor layer (122), an insulating layer (150) disposed on a part of the light emitting structure (120) and the first electrode (142), and a second electrode (146) conductively contacting the second conductivity-type semiconductor layer (126), the first electrode (142) including a first part (142-2) protruding from the side surface of the first conductivity-type semiconductor layer (122).

IPC 8 full level

H01L 33/20 (2010.01); **H01L 25/075** (2006.01); **H01L 27/15** (2006.01); **H01L 33/38** (2010.01); **H01L 33/44** (2010.01); **H01L 33/62** (2010.01)

CPC (source: CN EP KR US)

H01L 25/075 (2013.01 - CN); **H01L 25/0753** (2013.01 - EP US); **H01L 33/06** (2013.01 - US); **H01L 33/20** (2013.01 - EP US); **H01L 33/32** (2013.01 - US); **H01L 33/36** (2013.01 - CN KR); **H01L 33/38** (2013.01 - CN); **H01L 33/382** (2013.01 - EP US); **H01L 33/385** (2013.01 - CN EP US); **H01L 33/44** (2013.01 - EP US); **H01L 33/46** (2013.01 - EP US); **H01L 33/58** (2013.01 - US); **H01L 33/62** (2013.01 - EP US); **H01L 27/156** (2013.01 - EP US); **H01L 33/0093** (2020.05 - EP); **H01L 33/405** (2013.01 - EP US); **H01L 33/42** (2013.01 - EP US); **H01L 2924/0002** (2013.01 - EP US); **Y02E 10/544** (2013.01 - KR); **Y02P 70/50** (2015.11 - EP)

Cited by

US2019288171A1; US10847699B2

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

DOCDB simple family (publication)

EP 3038172 A2 20160629; **EP 3038172 A3 20160914**; **EP 3038172 B1 20220427**; CN 105742444 A 20160706; CN 105742444 B 20190913; JP 2016127289 A 20160711; JP 6755656 B2 20200916; KR 102322842 B1 20211108; KR 20160079276 A 20160706; US 2016190396 A1 20160630; US 9620683 B2 20170411

DOCDB simple family (application)

EP 15202624 A 20151223; CN 201510998904 A 20151228; JP 2015252329 A 20151224; KR 20140190407 A 20141226; US 201514981438 A 20151228